### **STL16N60M6**



# N-channel 600 V, 0.30 Ω typ., 8 A MDmesh™ M6 Power MOSFET in a PowerFLAT™ 5x6 HV package

Datasheet - production data

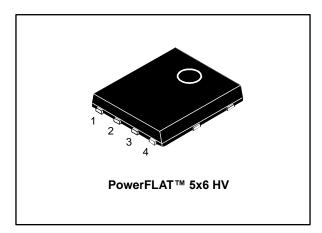
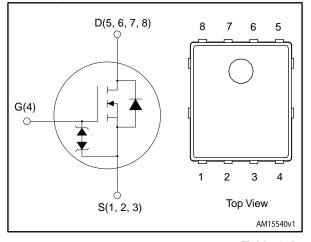


Figure 1: Internal schematic diagram



#### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	ΙD
STL16N60M6	600 V	0.35 Ω	8 A

- Reduced switching losses
- Lower R<sub>DS(on)</sub> x area vs previous generation
- Low gate input resistance
- 100% avalanche tested
- Zener-protected

### **Applications**

• Switching applications

### **Description**

The new MDmesh<sup>TM</sup> M6 technology incorporates the most recent advancements to the well-known and consolidated MDmesh family of SJ MOSFETs. STMicroelectronics builds on the previous generation of MDmesh devices through its new M6 technology, which combines excellent  $R_{DS(on)}$  \* area improvement with one of the most effective switching behaviors available, as well as a user-friendly experience for maximum endapplication efficiency.

**Table 1: Device summary** 

Order code	Marking	Package	Packing
STL16N60M6	16N60M6	PowerFLAT™ 5x6 HV	Tape and reel

Contents STL16N60M6

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STL16N60M6 Electrical ratings

### 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>G</sub> s	Gate-source voltage	±25	V
$I_D$	Drain current (continuous) at T <sub>C</sub> = 25 °C	8 <sup>(1)</sup>	Α
ΙD	Drain current (continuous) at T <sub>C</sub> = 100 °C	5 <sup>(1)</sup>	Α
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	32	Α
Ртот	Total dissipation at T <sub>C</sub> = 25 °C	52	W
dv/dt <sup>(3)</sup>	Peak diode recovery voltage slope	15	V/ns
dv/dt <sup>(4)</sup>	MOSFET dv/dt ruggedness	50	V/ns
T <sub>stg</sub>	Storage temperature range	-55 to 150	°C
Tj	Operating junction temperature range	-55 10 150	C

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	2.4	°C/W
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb	50	°C/W

#### Notes:

**Table 4: Avalanche characteristics** 

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by T <sub>jmax</sub> )	2.5	А
Eas	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$ , $V_{DD} = 50$ V)		mJ

<sup>&</sup>lt;sup>(1)</sup>This value is limited by package.

 $<sup>\</sup>ensuremath{^{(2)}}\mbox{Pulse}$  width is limited by safe operating area.

 $<sup>^{(3)}</sup>I_{SD} \leq 8$  A, di/dt  $\leq 400$  A/µs, VDS peak < V(BR)DSS, VDD = 80% V(BR)DSS

 $<sup>^{(4)}</sup>V_{DS} \le 480 \text{ V}$ 

 $<sup>^{(1)}</sup>$ When mounted on 1 inch $^2$  FR-4, 2 Oz copper board

Electrical characteristics STL16N60M6

### 2 Electrical characteristics

(T<sub>C</sub>= 25 °C unless otherwise specified)

Table 5: On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	600			V
	Zara gata valtaga drain	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}$			1	μΑ
IDSS	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V},$ $T_{C} = 125 \text{ °C}^{(1)}$			100	μΑ
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			±5	μΑ
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	3.25	4	4.75	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	V <sub>G</sub> S = 10 V, I <sub>D</sub> = 6 A		0.30	0.35	Ω

#### Notes:

Table 6: Dynamic

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
Ciss	Input capacitance	.,,	ı	575	-	pF
Coss	Output capacitance	$V_{DS}$ = 100 V, f = 1 MHz, $V_{GS}$ = 0 V	ı	33	-	pF
Crss	Reverse transfer capacitance	V 00 = 0 V	ı	3	-	pF
Coss eq. (1)	Equivalent output capacitance	$V_{DS} = 0$ to 480 V, $V_{GS} = 0$ V	ı	104	-	pF
R <sub>G</sub>	Intrinsic gate resistance	gate resistance f = 1 MHz open drain		5.2	-	Ω
$Q_g$	Total gate charge	$V_{DD} = 480 \text{ V}, I_D = 12 \text{ A},$	-	16.7	-	nC
Qgs	Gate-source charge	V <sub>GS</sub> = 0 to 10 V (see Figure 15: "Test circuit	-	3.5	-	nC
$Q_{gd}$	Gate-drain charge	for gate charge behavior")	-	9.4	-	nC

#### Notes:

**Table 7: Switching times** 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 300 \text{ V}, I_D = 6 \text{ A},$	ı	13	ı	ns
tr	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see Figure 14: "Test circuit	-	7.6	-	ns
t <sub>d(off)</sub>	Turn-off-delay time	for resistive load switching	ı	19.8	1	ns
tf	Fall time	times" and Figure 19: "Switching time waveform")		6.8		ns

 $<sup>^{(1)}</sup>$ Defined by design, not subject to production test.

 $<sup>^{(1)}</sup>$ Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS.

Table 8: Source drain diode

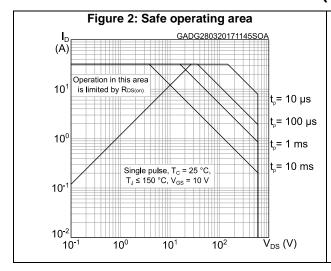
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		8	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		32	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 8 A	-		1.6	V
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 12 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	210		ns
Qrr	Reverse recovery charge	V <sub>DD</sub> = 60 V (see Figure 16: "Test circuit	-	1.7		μC
I <sub>RRM</sub>	Reverse recovery current	for inductive load switching and diode recovery times")	-	13.8		А
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 12 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	310		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 \text{ °C}$ (see Figure 16: "Test circuit	-	3.2		μC
I <sub>RRM</sub>	Reverse recovery current	for inductive load switching and diode recovery times")	-	15.4		Α

#### Notes:

 $<sup>^{(1)}</sup>$ Pulse width is limited by safe operating area.

 $<sup>^{(2)}\</sup>text{Pulse}$  test: pulse duration = 300  $\mu\text{s},$  duty cycle 1.5%

### 2.1 Electrical characteristics (curves)



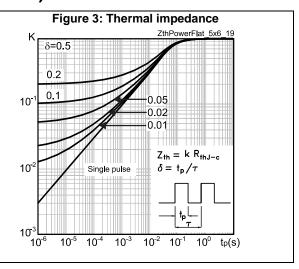
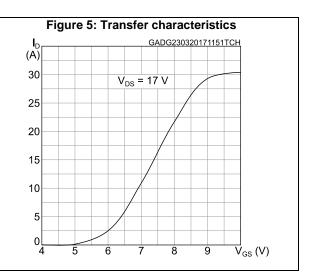


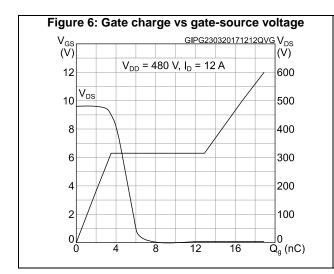
Figure 4: Output characteristics

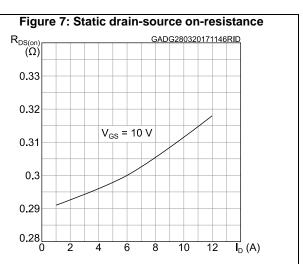
GADG2303201711140CH

V<sub>GS</sub> = 9, 10 V

V<sub>S</sub> = 9, 10 V







STL16N60M6 Electrical characteristics

Figure 8: Capacitance variations

C GADG230320171219CVR

103

104

C CISS

C CISS

1001

1001

1001

1001

1001

1001

1001

1001

1002

C CISS

C CIS

Figure 10: Normalized on-resistance vs temperature

R<sub>DS(on)</sub> (norm.)
2.2

1.8

1.4

1

0.6

0.2

-75

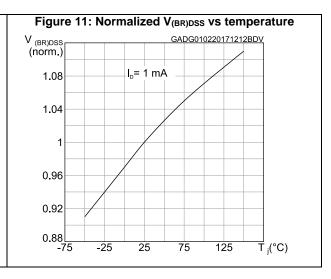
-25

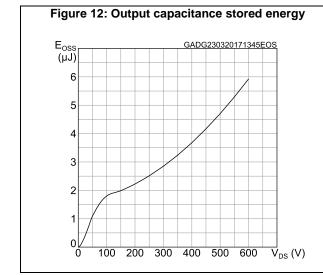
25

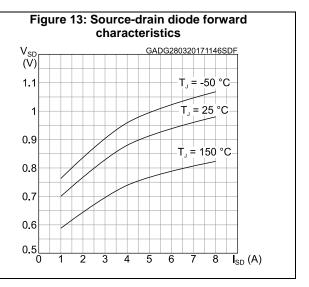
75

125

T<sub>j</sub> (°C)







Test circuits STL16N60M6

### 3 Test circuits

Figure 14: Test circuit for resistive load switching times

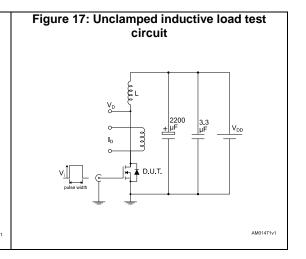
Figure 15: Test circuit for gate charge behavior

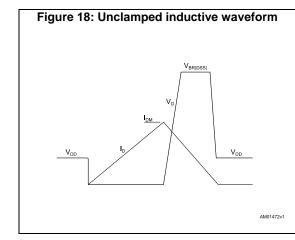
12 V 47 kΩ 100 nF 1 kΩ

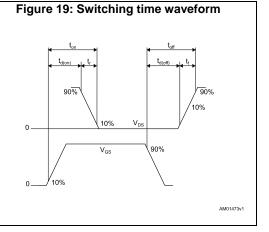
Vos 1 kΩ 1 kΩ

Vos 1 kΩ 1 kΩ

AM01466y1







# 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

# 4.1 PowerFLAT™ 5x6 HV package information

Figure 20: PowerFLAT™ 5x6 HV package outline

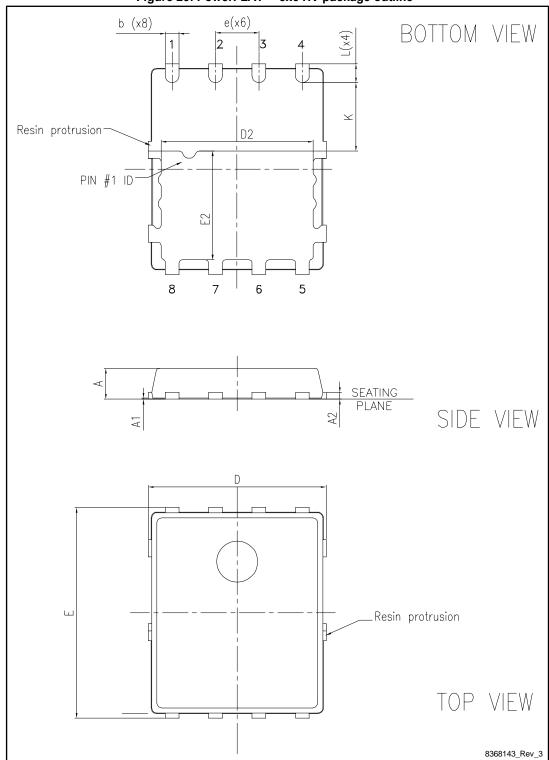
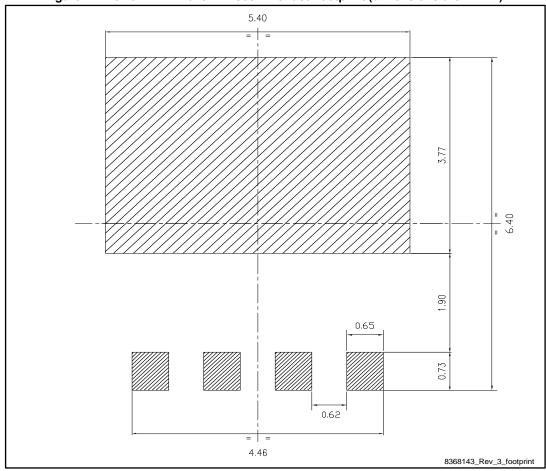


Table 9: PowerFLAT™ 5x6 HV mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
D	5.10	5.20	5.30
Е	6.05	6.15	6.25
E2	3.10	3.20	3.30
D2	4.30	4.40	4.50
е		1.27	
L	0.50	0.55	0.60
K	1.90	2.00	2.10

Figure 21: PowerFLAT™ 5x6 HV recommended footprint (dimensions are in mm)



Package information STL16N60M6

# 4.2 PowerFLAT™ 5x6 packing information

12/15

Figure 22: PowerFLAT™ 5x6 tape (dimensions are in mm)

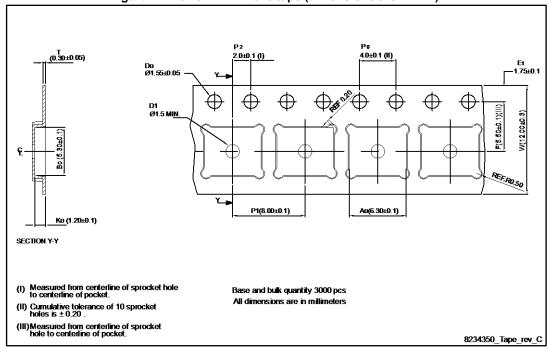


Figure 23: PowerFLAT™ 5x6 package orientation in carrier tape

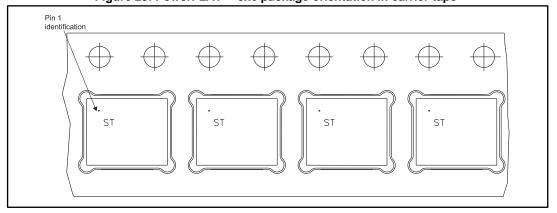


Figure 24: PowerFLAT™ 5x6 reel

PART NO.

R25.00

R25.

Revision history STL16N60M6

# 5 Revision history

Table 10: Document revision history

Date	Revision	Changes
03-Apr-2017	1	First release

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NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911

DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF